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Lextar.com

4-8W COB LED

Updated on 2013/02/06

Approval Sheet

4~8W COB LED Product Specification

СОВ
PB04H06
2013/02



Feature

- ✓ High Power DC white LED
- ✓ External dimension : 13.0mmx13.5mmx1.0mm
- ✓ ANSI white binning COB package
- ✓ Multi-GaN-based LED solution
- ✓ View angle 120°, uniform chromaticity profile
- ✓ Pb free
- ✓ Green product, remain within RoHS
- ✓ Thermocouple attaching point

Applications

- ✓ Indoor general lighting
- Decoration lighting

	MAKER		CUST	OMER	
Prepared	Checked	Approved			



Outline Dimension

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Note: Circuit layout is 3 series and 8 parallels



Performance

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Product Specification

Electro-Optical Characteristics

Parameter	Symbol	Condition	Min.	Typical	Max.	Unit
Forward Voltage ⁽¹⁾	VF		8.5	9	10.5	V
Color Tomporaturo ⁽²⁾				2700		K
	001	1 490 mA		3000		TX .
Color Rendering Index	Ra	$I_F = 400 IIIA$	80			
View Angle	θ			120		deg
Thermal Resistance	Rth			2.5		°C/W

Parameter	Symbol	Condition	Min.	Typical	Max.	Unit
Forward Voltage ⁽¹⁾	VF		8	9	10.5	V
Color Tomporaturo ⁽²⁾	or Tomporaturo ⁽²⁾			5000		K
Color remperature	olor remperature CCT	$I_{F} = 480 \text{ mA}$		5700		rx
Color Rendering Index	Ra		70			
View Angle	θ			120		deg
Thermal Resistance	Rth			2.5		°C/W

(1) The Forward Voltage tolerance is \pm 3%.

(2) Correlated Color Temperature is derived from the CIE 1931Chromaticity diagram.

Luminous Flux⁽¹⁾ (Ta=25^oC)

ССТ	Condition	Lumen			Unit
CCI	Condition	Min.	Typical	Max.	Onit
2700K		400	420		
3000K	I _F = 480 mA	420	440		١m
5000K		500	520		
5700K		480	500		

(1) The luminous flux tolerance is $\pm 10\%$

(2) The power consumption is typical value.

Absolute Maximum Ratings

Parameter	Symbol		Unit
DC Forward Current ⁽¹⁾	Ι _F	960	mA
Power Dissipation	Pd	8	W
Storage Temperature	Ts	-40 ~ 100	°C
Junction Temperature	TJ	125	°C
Substrate Temperature	T _{sub}	100	°C
Manual Soldering Time at 300 °C(Max)	T_{sol}	60	sec

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time.

(2) Thermal resistance is calculated from junction to substrate.

Chromaticity Coordinates



CIE-y CIE-x CIE-x CIE-v 0.4501 0.402 0.4449 0.3968 0.4576 0.4158 0.457 0.4198 273 275 0.4666 0.4179 0.4724 0.4235 0.4588 0.404 0.459 0.4002 0.4422 0.4113 0.4317 0.4113 0.4079 0.3892 0.4328 0.4218 303 305 0.3943 0.4267 0.3946 0.4363 0.417 0.4355 0.3977 0.4476 0.3425 0.3579 0.3406 0.3594 0.3487 0.3629 0.3396 0.3435 503 505 0.3477 0.353 0.3492 0.3512 0.3418 0.3483 0.3511 0.3679 0.3325 0.3492 0.3345 0.354 0.3258 0.3432 0.3238 0.3444 573 575 0.3263 0.335 0.3246 0.3308 0.332 0.3401 0.3336 0.3387

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(1) Tolerance of measurement is Chromaticity (x,y) \pm 0.005



Binning	4~8W COB LED Product Specification
Binning	Product Specification

Binning (I_F=480mA, Ta=25⁰C)

ССТ	Step	CRI	Lumen	V _F
50	3	8	L1	AI

CCT Bin Code	ССТ
273/ 275	2700K-3/5step
303/ 305	3000K-3/5step
503/ 505	5000K-3/5step
573/ 575	5700K-3/5step

CRI Bin Code	CRI
8	>80
7	>70

Lumen	Lumer	Lumen Range			V _F Bin	
Bin Code	From	То			Code	Fro
L1	380	417			AI	8
L2	417	454				
L3	454	490				
L4	490	543				
L5	543	595				
	ſ	VI1	595)	648	
	r	V12	648	3	706	
	r	VI3	706)	770	
	ſ	VI4	770)	839	

V _F Bin	V _F F	Range
Code	From	То
AI	8	10.5

Note:

- (1) Correlated color Temperature is derived from the CIE 1931Chromaticity diagram.
- (2) The CRI tolerance is ± 2
- (3) The Forward Voltage tolerance is \pm 3%.



Characteristics

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3000K





5000K



5700K







Radiation Pattern (IF=480mA, Ta=25^oC)







Forward Current vs. Related Luminous Flux (Ta=25⁰C)







Substrate Temperature vs. Forward Voltage (I_F=480mA)









Substrate Temperature vs. Chromaticity Coordinate (I_F=480mA) 2700K















Forward Current vs. Chromaticity Coordinate (Ta=25⁰C) 2700K















Reliability

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No	Item	Condition	Time/Cycle
1	2 nd Temp. Operation Life Test	Tc=85℃, I _F =720mA	1000 Hrs
2	High Temp. and High Humidity	85℃, 85%RH I _F =720mA	1000 Hrs
	Operation Life Test		
3	High Temp. Storage	85 ℃	1000 Hrs
4	Low Temp. Storage	-40°C	1000 Hrs
5	Temperature Cycle Storage	-40°C ~100°C (30min dwell)	300 cles
		/<5min transfer	

Judgment Criteria

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	Note1	Δ% < 10 %
Luminous Flux	lv	Note1	Decay < 30 %

Notes:

1. Refer to operating Current and Luminous Flux Characteristics for different value operating current regarding each type of Light Engine Series.



Packing

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Tray



Tray contains 100 units



Precautions

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- 1. Avoid the application of any stress to the resin portion (lighting area).
- 2. Avoid any contact by a sharp metal nail or other materials with the resin portion (lighting area).



3. This product should be secured firmly by fastening screws on both sides of the product. Please be careful not to apply any stress to the product during the clamping operation.



- 4. For fixing this product to the outer heat sink, thermal pad or thermal glue should be applied between backside of substrate and heat sink so that the product can dissipate heat completely. Please avoid product deformation when fixing the clamping operation.
- 5. Handling of static electricity
 - These products are sensitive to static electricity charge. Please prevent any static electricity within the assembling process.
 - All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
 - ESD sensitivity of this product is 1000V (HBM, based on JEITA ED-4701/304).
 - It is easy to find static-damaged LEDs by a light-on test.
- Before open the package, should kept at room temperature, 90% RH environment or less. The LED should be used within 6 months.
- 7. After open the package, the LED should be kept at room temperature, 60% RH environment or less. The LED should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel).
- 8. Applying proper resistor for the circuit design is recommended. Otherwise slight voltage shift may cause big current change and the LED may be burn out.
- 9. Please ensure that heat and electronic generation is not in excess of the absolute maximum rating.

Smart Lighting Amazing Life

Lextar Electronics Corp. is the leading LED (Light Emitting Diode)

maker integrating upper stream epitaxial, middle stream chip, and downstream package,

SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics,

the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight.

Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China.

The company turnover in 2010 is 266 million USD.